

孫 本 一 喜
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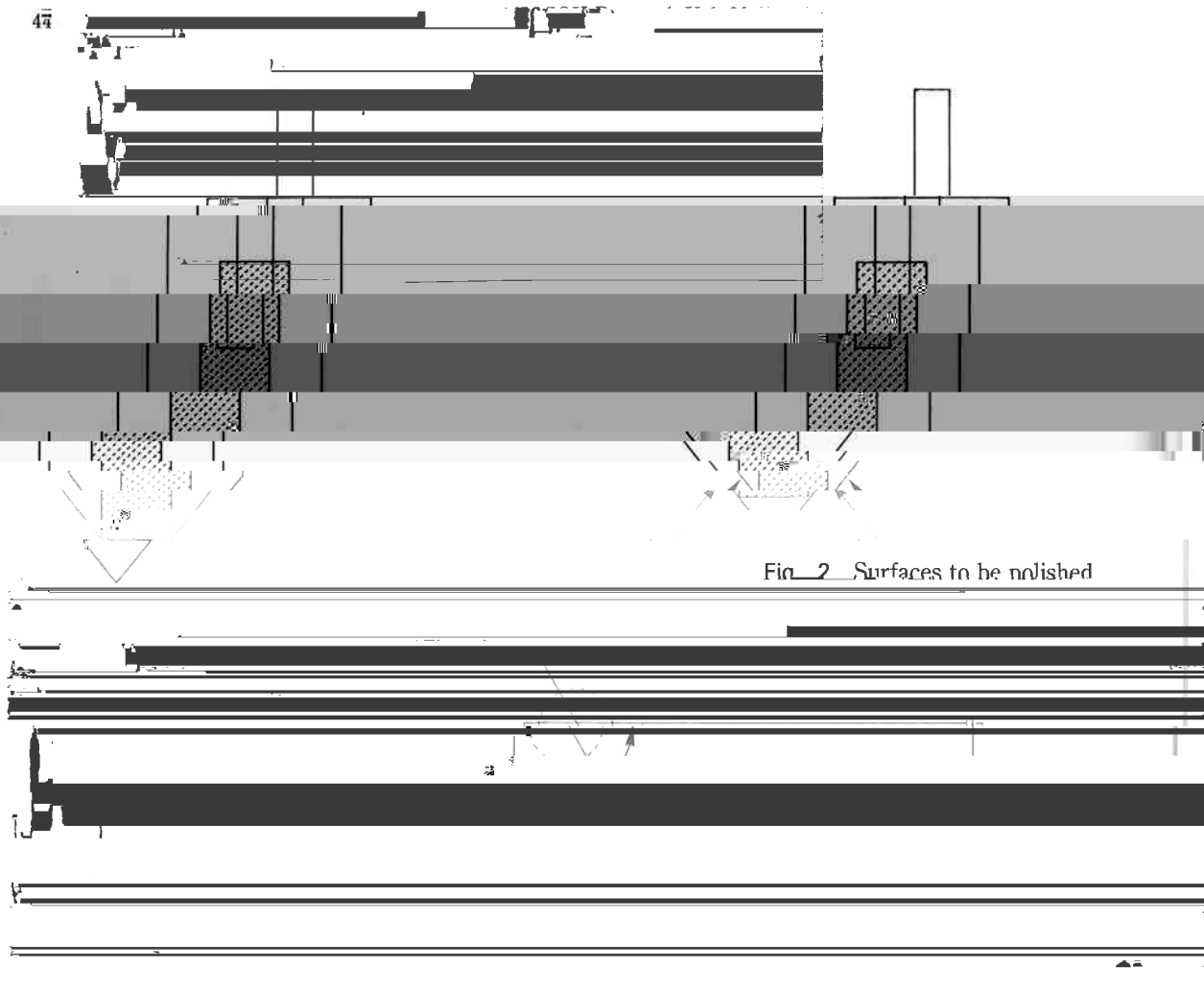
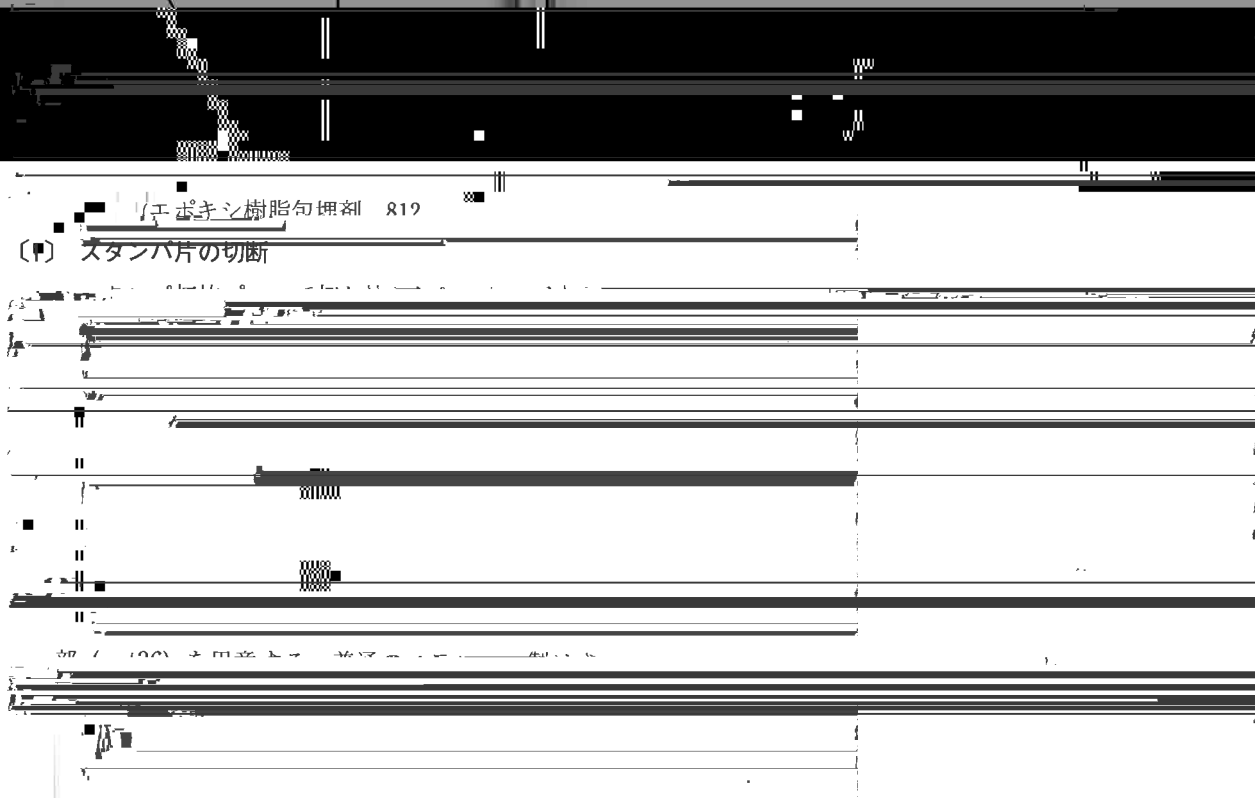


Fig. 2 Surfaces to be finished

としたい。

マイクロメータによる断面 TCM 佐制手順



エポキシ樹脂 埋め 219

(F) スタンプの切断

20 / 100 5 10 15 20 25 30 35 40 45 50 55 60 65 70 75 80 85 90 95 100



は 0.5 mm/秒 とする。

ガラスナイフは左側から使う (Fig. 4)。ガラス

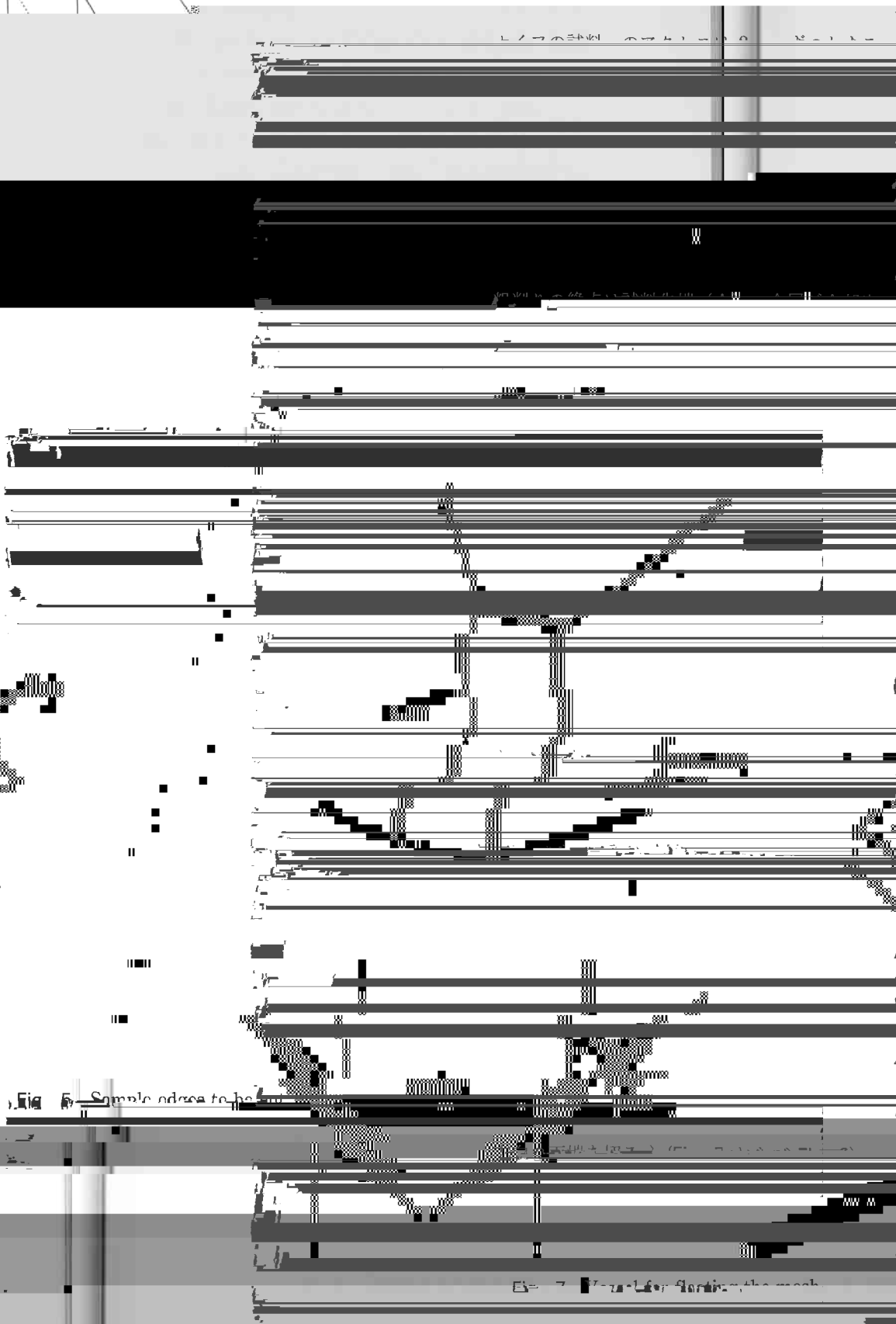


Fig. 6 Sample area to be

Fig. 7 Time-Lapse scanning the track



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Ni 96.1 96.2 95.8 96.2 96.2 96.2 96.2

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5.5



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